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N-Channel SuperFET[®] II Easy-Drive MOSFET

600 V, 52 A, 70 m Ω

Features

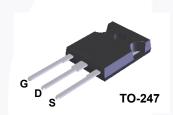
- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 58 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 128 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 457 pF)
- 100% Avalanche Tested
- RoHS Compliant

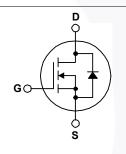
Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the Super-FET II MOSFET series.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCH070N60E	Unit	
V _{DSS}	Drain to Source Voltage	600	V	
V _{GSS}		- DC	±20	V
	Gate to Source Voltage	- AC (f > 1 H	tz) ±30	- V
I _D	Drain Current	- Continuous (T _C = 25 ^o C)	52	A
		- Continuous (T _C = 100 ^o C)	33	
DM	Drain Current	- Pulsed (Note	1) 156	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2) 1128	mJ
AR	Avalanche Current (Note 1)		1) 9.5	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		1) 4.8	mJ
al / alt	MOSFET dv/dt	100	V/ns	
dv/dt	Peak Diode Recovery dv/dt	3) 20		
P _D	Dawen Diagingtion	(T _C = 25 ^o C)	481	W
	Power Dissipation	- Derate Above 25°C	3.85	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FCH070N60E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	-0/00

April 2015

Part Nu			Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCH070			TO-247	Tube	N/A		N/A	30 units	
Electrica	al Char	acteristics T _C =	25°C unless	otherwise noted.					
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Chara	cteristic	s							
D) (V _{DSS} Drain to Source Breakdown Voltage			V _{GS} = 0 V, I _D = 10 mA, T _J = 25°C		600	-	-	V
BV _{DSS}			oltage	V _{GS} = 0 V, I _D = 10 mA	, T _J = 150°C	650	-	-	V
ΔΒV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient		ure	$I_D = 10$ mA, Referenced to $25^{\circ}C$		-	0.7	-	V/ºC
-	Zoro Cr			V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	
DSS	DSS Zero Gate Voltage Drain Cur		ent	V_{DS} = 480 V, V_{GS} = 0		-	3.4	-	μΑ
I _{GSS}	Gate to	Body Leakage Curren	nt	V_{GS} = ±20 V, V_{DS} = 0	V	-	-	±100	nA
On Chara	cteristic	s							
V _{GS(th)}	Gate Th	nreshold Voltage		$V_{GS} = V_{DS}, I_{D} = 250 \ \mu$	A	2.5	-	3.5	V
R _{DS(on)}	Static D	rain to Source On Re	sistance	V _{GS} = 10 V, I _D = 26 A		-	58	70	mΩ
9 _{FS}	Forward Transconductance			V _{DS} = 20 V, I _D = 26 A		-	44	-	S
Dynamic (Characte	eristics							
C _{iss}	Input Ca	put Capacitance				-	3705	4925	pF
C _{oss}	Output	Capacitance		$V_{DS} = 380 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		-	116	155	pF
C _{rss}	Reverse	Reverse Transfer Capacitance				-	12.3	20	pF
C _{oss(eff.)}	Effective Output Capacitance			V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	457	-	pF
Q _{g(tot)}	Total Ga	ate Charge at 10V		$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 26 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	128	166	nC
Q _{gs}	Gate to	Source Gate Charge				-	18	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				-	54	-	nC
ESR	Equivalent Series Resistance			f = 1 MHz		-	0.6	-	Ω
Switching	Charac	teristics							
t _{d(on)}	Turn-Or	Delay Time		V_{DD} = 380 V, I _D = 26 A, V _{GS} = 10 V, R _g = 4.7 Ω		•	29	68	ns
t _r	Turn-Or	n Rise Time					28	66	ns
t _{d(off)}	Turn-Of	f Delay Time				-	122	254	ns
t _f	Turn-Of	Turn-Off Fall Time		(Note 4)		-	28	66	ns
Drain-Sou	rce Diod	de Characteristic	S						
I _S	Maximu	m Continuous Drain to	Source Diode	de Forward Current		-	-	52	Α
I _{SM}	Maximum Pulsed Drain to Source Diode F		Irce Diode For			-	-	156	Α
V _{SD}	Drain to Source Diode Forward Voltage		d Voltage	V _{GS} = 0 V, I _{SD} = 26 A		-	-	1.2	V
t _{rr}	Reverse	Recovery Time		$V_{GS} = 0 V, I_{SD} = 26 A,$ dI _F /dt = 100 A/µs		-	463	-	ns
Q _{rr}	Reverse	Recovery Charge				-	10.4	-	μC

4. Essentially independent of operating temperature.

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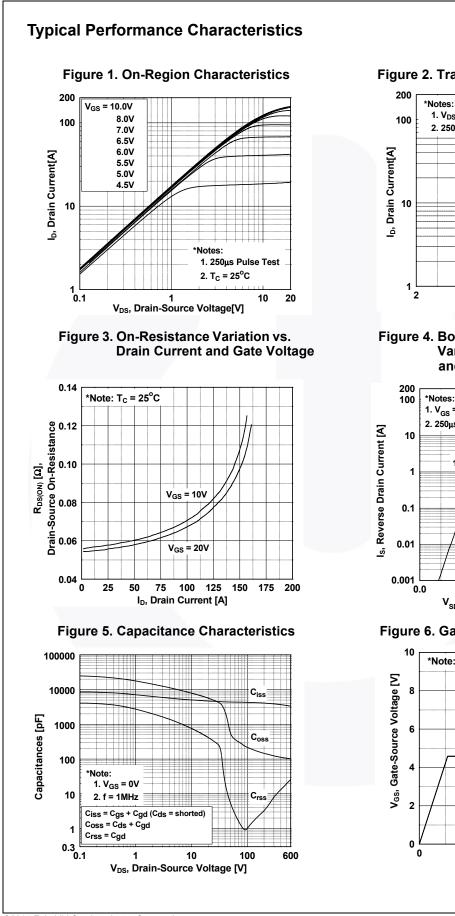


Figure 2. Transfer Characteristics

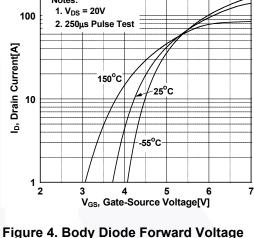
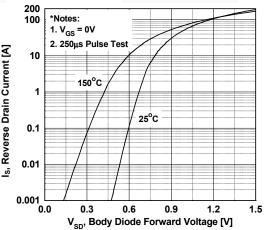
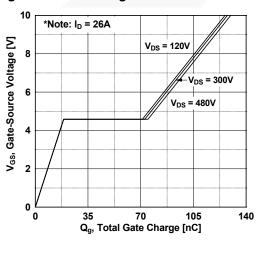


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



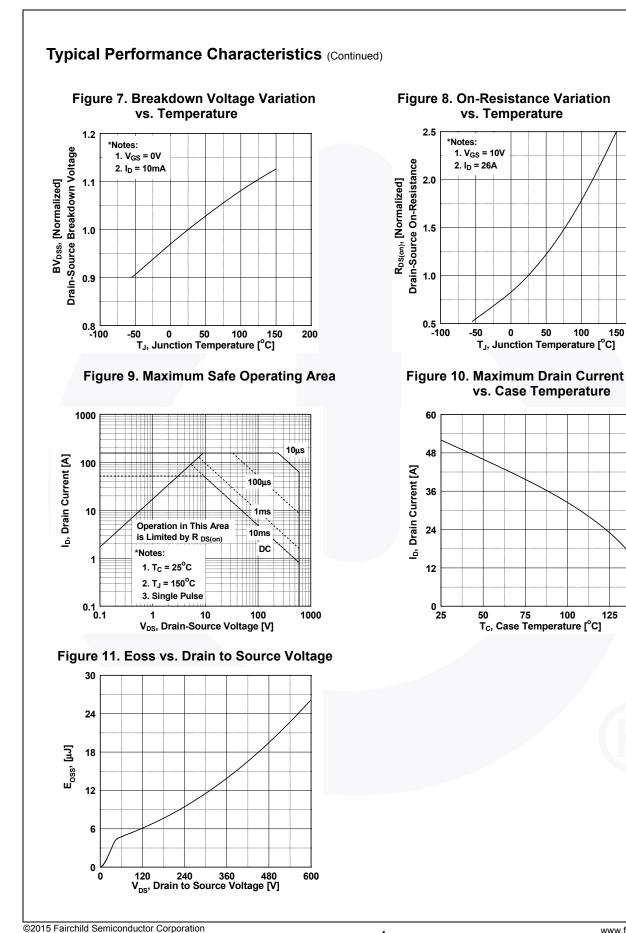




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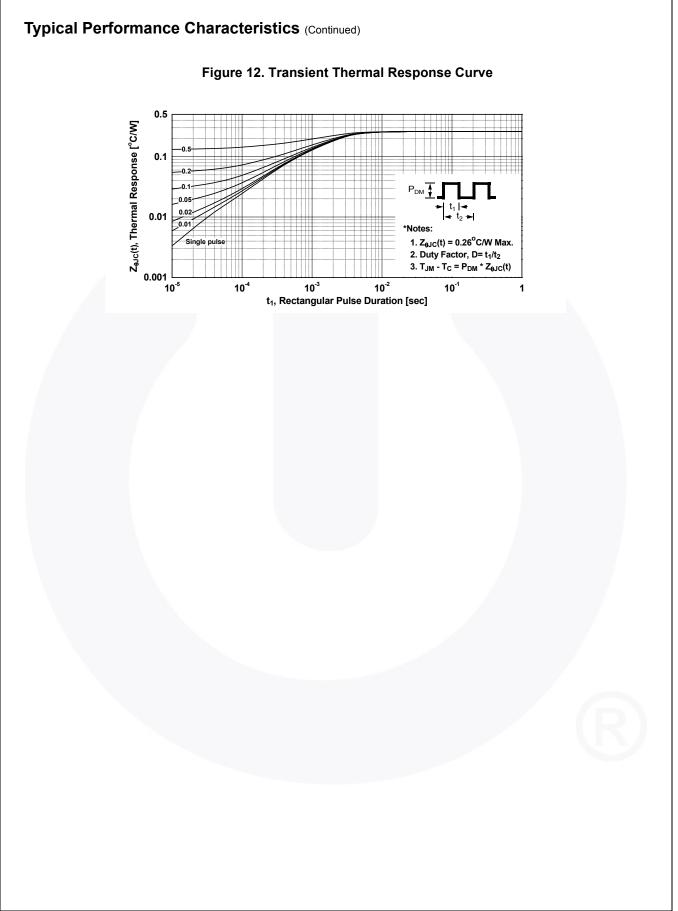
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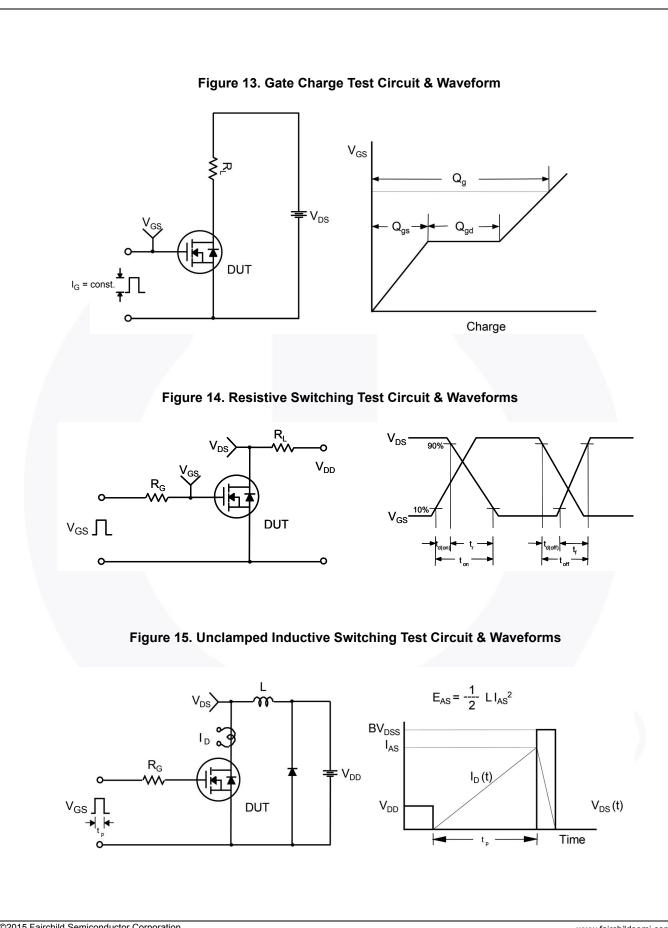


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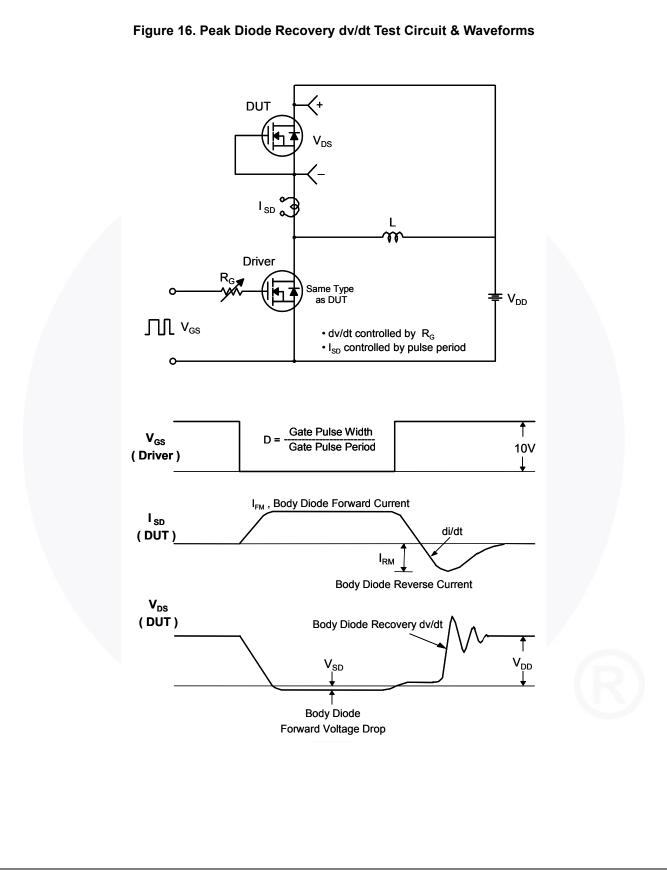
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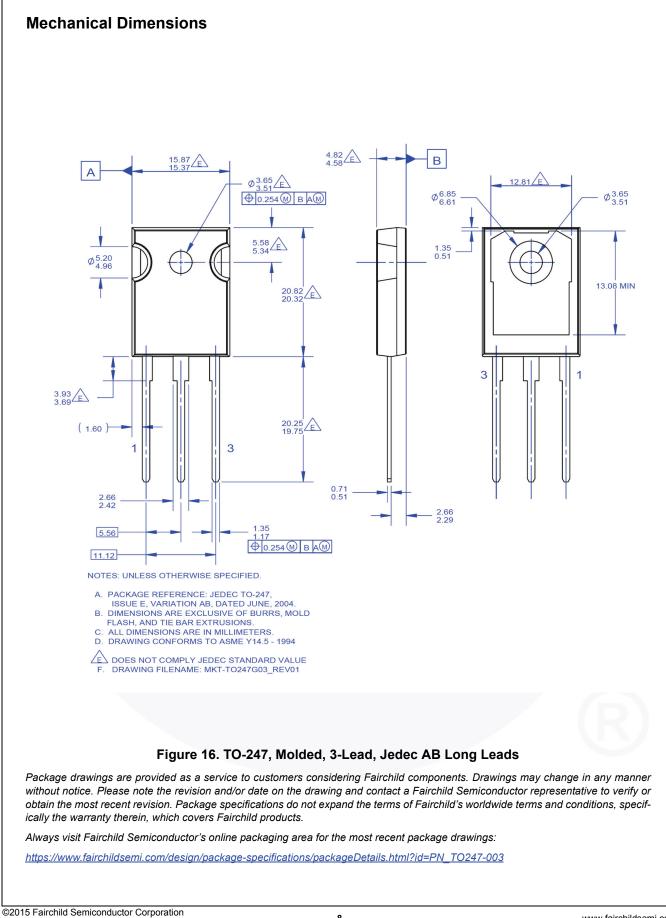
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